



### 10A SURFACE MOUNT DUAL SCHOTTKY BARRIER RECTIFIER POWERMITE® 3

#### **Features**

## NOT RECOMMENDED \_\_\_\_\_\_ FOR NEW DESIGNS \_\_\_\_\_ USE PDS1040CTL

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- Very Low Reverse Leakage Current
- For Use in Low Voltage, High Frequency Inverters, OR'ing, and Polarity Protection Applications
- Available in Lead Free Finish/RoHS Compliant Version (Note 1)

# $\begin{array}{c|c} & A \\ & P \\ & P \\ & A \\ & P \\ & A \\ & G \\ & A \\$

PIN 3, BOTTOMSIDE HEAT SINK

POWERMITE®3			
Dim	Min	Max	
Α	4.03	4.09	
В	6.40	6.61	
С	.864	.914	
D	1.83 NOM		
E	1.10	1.14	
G	.173	.203	
Н	5.01	5.17	
J	4.37	4.43	
K	.173	.203	
L	.71	.77	
M	.36	.46	
Р	1.73	1.83	
All Dimensions in mm			

#### **Mechanical Data**

- Case: POWERMITE®3 Molded Plastic
- Plastic Material: UL Flammability Classification Rating 94V-0
- Moisture sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Marking: See Page 4
- Weight: 0.072 grams (approx.)

#### Maximum Ratings @ T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Rectified Output Current (Also see Figure 5) per element total device	Io	5 10	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load Per Package, total device $T_C = 115^{\circ}C$	I <sub>FSM</sub>	50	А
Typical Thermal Resistance Junction to Soldering Point Per Element	R <sub>θ</sub> JS	2.5	°C/W
Operating Temperature Range	Tj	-55 to +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

Notes: 1. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

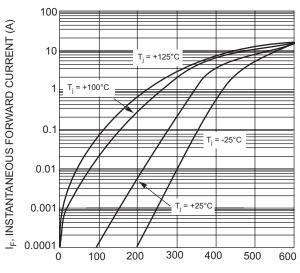


#### Electrical Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

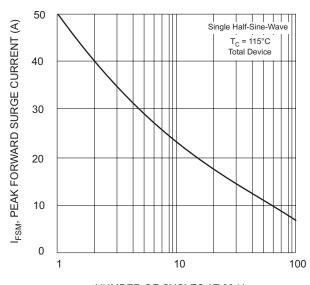
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)		$V_{(BR)R}$	40	_	_	V	$I_R = 500 \mu A$
Forward Voltage	Per Element	VF		0.45 0.39 0.53 0.50	0.48 0.42 0.575 0.55	V	$\begin{array}{ll} I_F = 5A, \ T_j = \ 25^{\circ}C \\ I_F = 5A, \ T_j = \ 100^{\circ}C \\ I_F = 10A, \ T_j = \ 25^{\circ}C \\ I_F = 10A, \ T_j = \ 100^{\circ}C \\ \end{array}$
Reverse Current (Note 2)	Per Element	I <sub>R</sub>		35 4 10 2	150 10 80 5	μΑ mA μΑ mA	$\begin{array}{l} V_R = 35 V,  T_j =  25^{\circ} C \\ V_R = 35 V,  T_j =  100^{\circ} C \\ V_R = 17.5 V,  T_j =   25^{\circ} C \\ V_R = 17.5 V,  T_j =  100^{\circ} C \end{array}$
Total Capacitance	Per Element	Ст	_	375	_	pF	f = 1.0MHz, V <sub>R</sub> = 4.0V DC

Notes:

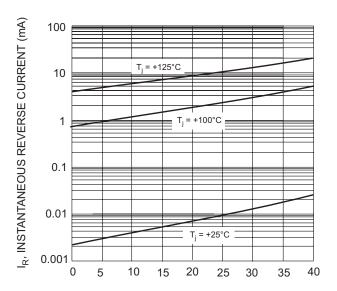
2. Short duration test pulse used to minimize self-heating effect.



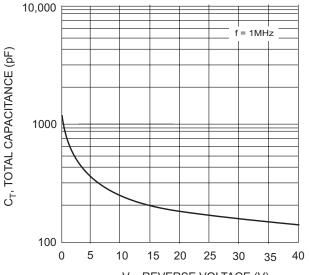
V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (mV) Fig. 1 Typical Forward Characteristics, Per Element



NUMBER OF CYCLES AT 60 Hz Fig. 3 Max Non-Repetitive Peak Fwd Surge Current



 $\rm V_R$ , INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics, Per Element



V<sub>R</sub>, REVERSE VOLTAGE (V) Fig. 4 Typical Capacitance vs. Reverse Voltage, Per Element

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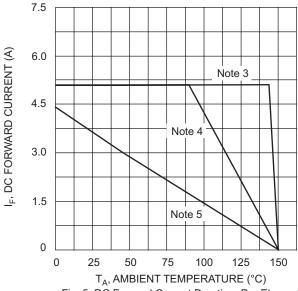


Fig. 5 DC Forward Current Derating, Per Element

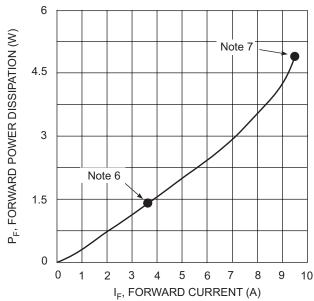


Fig. 6 Forward Power Dissipation, Per Element

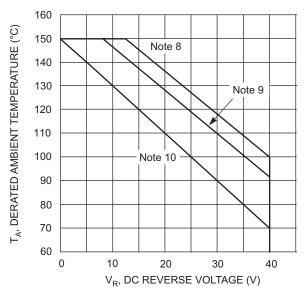


Fig. 7 Operating Temperature Derating, Per Element

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Notes:

- 3.  $T_A = T_{SOLDERING\ POINT},\ R_{\theta JS} = 2.5^{\circ}C/W,\ R_{\theta SA} = 0^{\circ}C/W.$
- Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R<sub>θJA</sub> in range of 25-30°C/W.
- Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R<sub>BJA</sub> in range of 05 100°CAM.
- 6. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 4.
- 7. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 3.
- 8. R<sub>0,JA</sub> = 10-15°C/W when mounted on 2"x2", single-sided, ceramic board with cathode pad dimensions 0.75"x1.0", anode pad dimensions 0.25"x1.0".
- 9.  $R_{\theta,JA} = 20-25^{\circ}\text{C/W}$  when mounted on 2"x2", single-sided, FR-4 board with cathode pad dimensions 0.5"x1.0", anode pad dimensions 0.5"x1.0", 2 oz. copper pads.
- 10. R<sub>0JA</sub> = 60-65°C/W when mounted on 0.5"x0.625", single-sided, FR-4 board with minimum recommended pad layout.



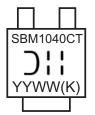
#### Ordering Information (Note 11)

Device	Packaging	Shipping
SBM1040CT-13	POWERMITE®3	5000/Tape & Reel

Notes:

- 11. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
- 12. For Lead Free Finish/RoHS Compliant version part number, please add "-F" suffix to the part number above. Example: SBM1040CT-13-F.

#### **Marking Information**



SBM1040CT = Product type marking code

O!! = Manufacturers' code marking

YYWW = Date code marking

YY = Last digit of year ex: 02 for 2002

WW = Week code 01 to 52

(K) = Factory designator

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